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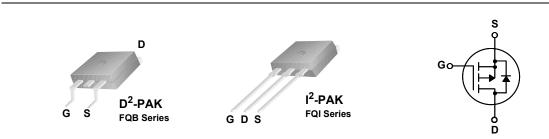
# **FQB11P06 / FQI11P06** P-Channel QFET MOSFET -60 V, -11.4 A, 175 mΩ

## Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

### Features

- 11.4 A, -60 V,  $R_{DS(on)}$  = 175 m $\Omega$  (Max) @V\_{GS} = -10 V,  $I_{D}$  = -5.7 A
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 45 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating



## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQB11P06 / FQI11P06	Unit
V <sub>DSS</sub>	Drain-Source Voltage		-60	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		-11.4	А
	- Continuous (T <sub>C</sub> = 100°C)		-8.05	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-45.6	А
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	160	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-11.4	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns
PD	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.13	W
	Power Dissipation $(T_C = 25^{\circ}C)$		53	W
	- Derate above 25°C		0.35	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C
Τ <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

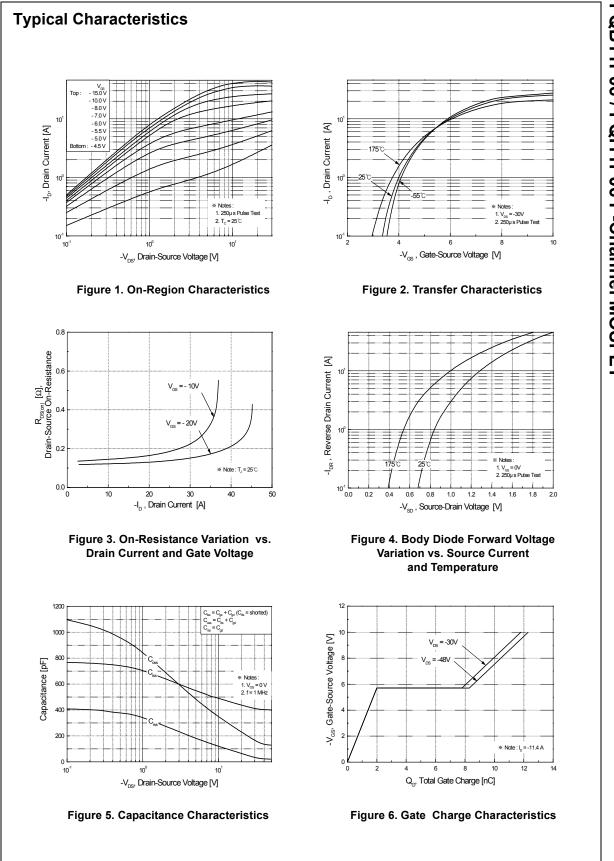
## **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case		2.85	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient *		40	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

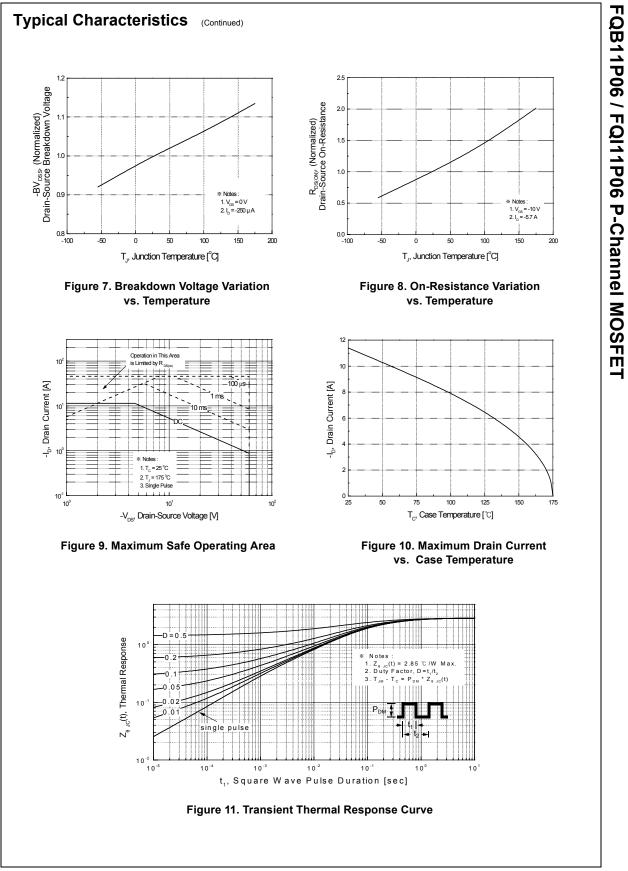
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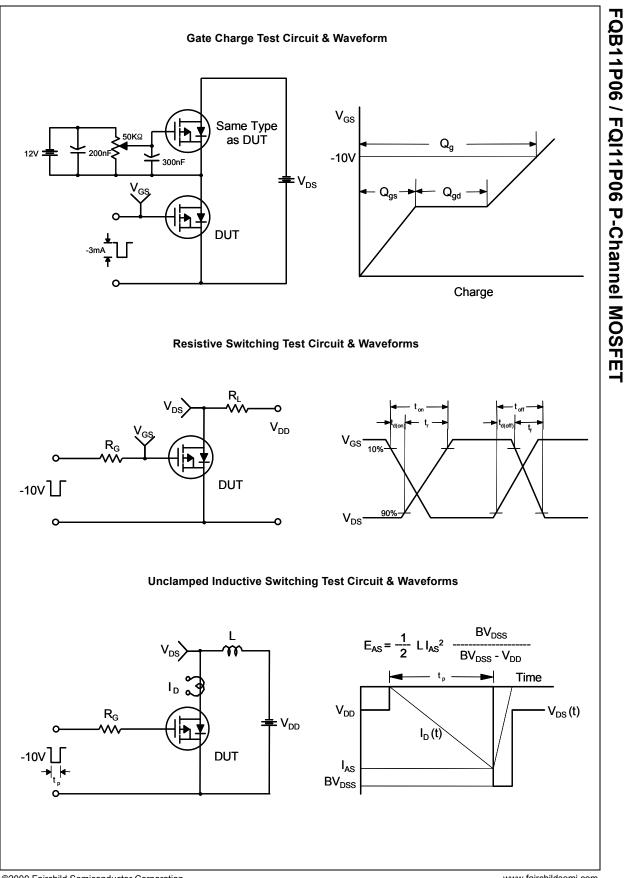
March 2013

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-60			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-0.07		V/°C
I <sub>DSS</sub>		$V_{DS}$ = -60 V, $V_{GS}$ = 0 V			-1	μA
	Zero Gate Voltage Drain Current $V_{DS} = -48 \text{ V}, T_C = 150^{\circ}\text{C}$				-10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS}$ = -25 V, $V_{DS}$ = 0 V			-100	nA
GSSR	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = 25 V, V <sub>DS</sub> = 0 V			100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-2.0		-4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5.7 A		0.14	0.175	Ω
JFS	Forward Transconductance	V <sub>DS</sub> = -30 V, I <sub>D</sub> = -5.7 A (Note 4	)	5.1		S
Ciss Coss Crss	C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>DS</sub> = -25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		420 195 45	550 250 60	pF pF pF
Switchi	ng Characteristics					
d(on)	Turn-On Delay Time	V <sub>DD</sub> = -30 V, I <sub>D</sub> = -5.7 A,		6.5	25	ns
ŕ	Turn-On Rise Time	$R_G = 25 \Omega$		40	90	ns
d(off)	Turn-Off Delay Time	(Note 4, 5		15	40	ns
f	Turn-Off Fall Time		"	45	100	ns
2 <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -48 V, I <sub>D</sub> = -11.4 A,		13	17	nC
2 <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -10 V		2.0		nC
2 <sub>gd</sub>	Gate-Drain Charge	(Note 4, 5	)	6.3		nC
	ource Diode Characteristics ar	•		I	1	
S	Maximum Continuous Drain-Source Dio				-11.4	A
SM	Maximum Pulsed Drain-Source Diode F				-45.6	A
/ <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -11.4 A$			-4.0	V
n N	Reverse Recovery Time	$V_{GS} = 0 V, I_S = -11.4 A,$ $dI_F / dt = 100 A/\mu s$ (Note 4		83		ns
2 <sup>u</sup>	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A}/\mu \text{s}$ (Note 4	•)	0.26		μC
L = 1.44mH, I <sub>SD</sub> ≤ -11.4A Pulse Test :	ating : Pulse width limited by maximum junction temper $I_{AS}$ = -11.4A, $V_{DD}$ = -25V, $R_G$ = 25 $\Omega$ , Starting $T_J$ = 25, di/dt $\leq$ 3004/µs, $V_{DD}$ $\leq$ BV $_{DSS}$ , Starting $T_J$ = 25°C Pulse width $\leq$ 300µs, Duty cycle $\leq$ 2% independent of operating temperature					



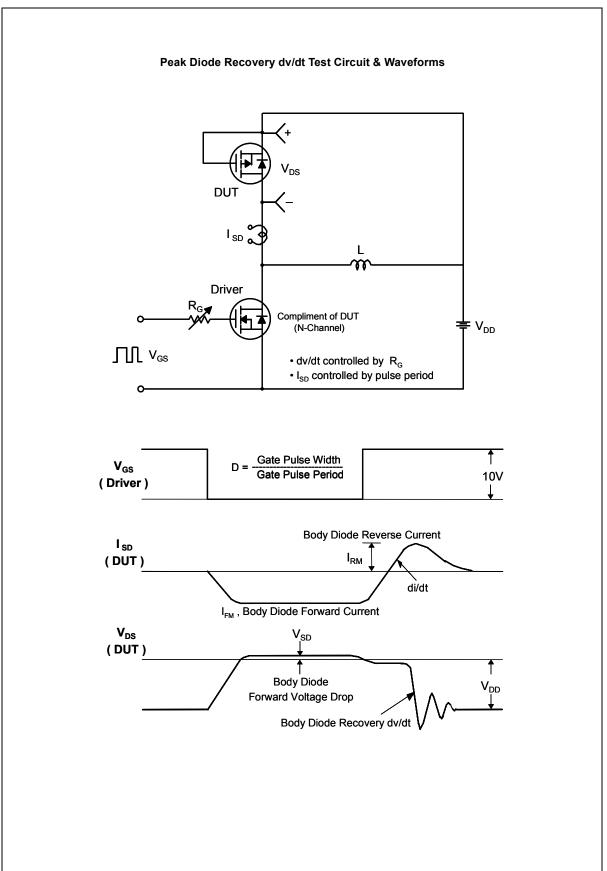
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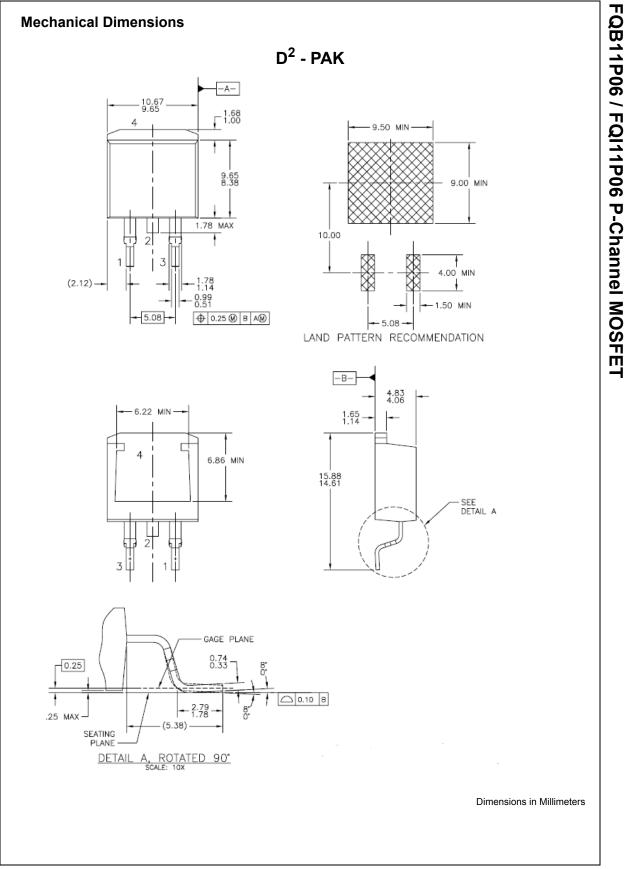




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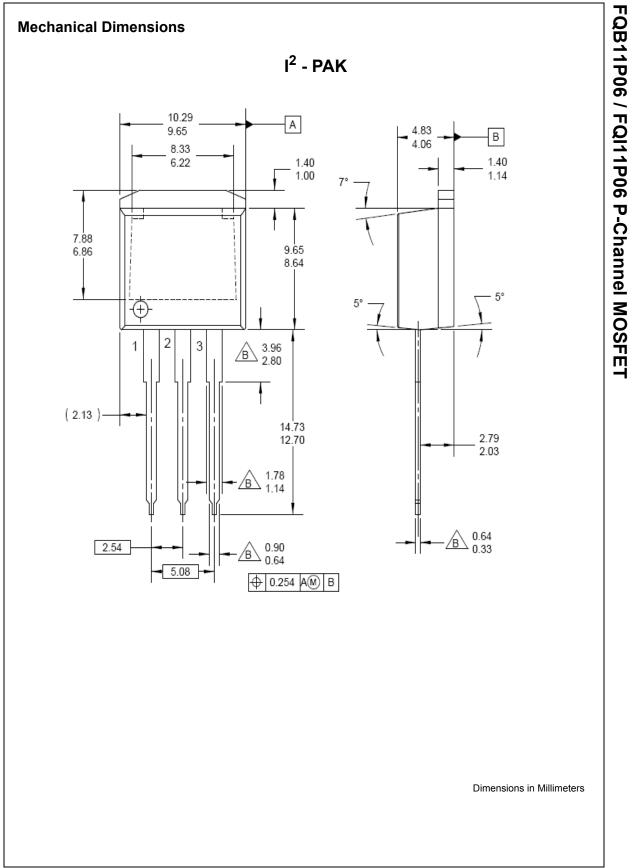
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